RHODUNA® Diamond Bright

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Operating Instructions Edition: 13 February 2015 Rhodium Concentrate with <u>2 g Rh/100 ml</u>		 Brilliant-white rhodium for decorative applications Ultra-bright coatings with previously unattained lightness and brilliance Good covering speed Excellent throwing power Layer thicknesses of up to 5 µm can be 			
			depositedFor rack and barrel operation		
				•	
Electrolyte Characteristics			Electrolyte replenishment:	 b) RHODUNA[®] Diamond Bright Replenisher Solution 100 ml containing 5 g rhodium Storage stability: min. 2 years 	
RHODUNA [®] Diamond Bright deposits brilliant-white, ultra-bright coatings of previously unattained lightness and brilliance. It is additionally characterized by high covering speed and excellent throwing power. Further-					
more, from RHODUNA [®] Diamond Bright layer thick- nesses of up to 5 µm can be deposited crack-free.			Electrolyte Makeup		
Rhodium can be directly deposited on silver, gold, copper and copper alloys, nickel and nickel alloys.			Makeup sequence:	For 1 litre of RHODUNA [®] Diamond Bright electrolyte with 2 g/l Rh:	
When plating tin, lead, zinc, aluminium and iron, inter- mediate nickel coatings of some µm thickness are ab- solutely essential. Strike nickel plating is advanta- geous with all substrates.				Slowly stir 100 ml of RHODUNA [®] Diamond Bright Rhodium Concen- trate (2 g Rh/100 ml) into 750 ml of	
Rhodium content	: 2 g/l (1.6 – 3 g/l)			deionized water. Then add 100 ml of RHODUNA [®] Diamond Bright Addi-	
pH-value:	< 1			tive Solution and fill up to 1 litre with	
Temperature:	40 °C (RT – 65 °C)			deionized water.	
Current density:	1 – 2 A/dm ² (0.5 – 10 A/dm ²)				
Voltage:	2 volts (2 – 4 volts)		Operating (Conditions	
Deposition speed:	0.08 μm/min at 1 A/dm ² 0.10 μm/min at 2 A/dm ²		Electrolyte density:	1.023 g/cm ³ when newly made up, slowly rising	
Deposition rate: Current	9.4 mg rhodium/Amin at 1 A/dm ² , 5.9 mg rhodium/Amin at 2 A/dm ² 44 % at 1 A/dm ²		Sulphuric acid	30 g/l after electrolyte makeup with 2 g/l Rh	
efficiency:	27 % at 2 A/dm ²			•	
Coating Cha			Product agitation:	Optional. Mechanical tapping to dis- lodge adhering hydrogen bubbles is recommended.	
Coating:	Rhodium		Barrel plating:	RHODUNA [®] Diamond Bright is also	
Colour: Hardness:	Brilliant white Approx. 800 – 900 HV		suitabl	suitable for barrel plating.	
Density of coating:	Approx. 12.4 g/cm ³			Recommended standard values: Current density: approx. 1 A/dm ²	
Max. coating thickness:	Approx. 3 – 5 µm			Voltage: 6 - 9 volts Temperature: 40 °C	
Form of Supply				Deposition speed: approx. 0.03 µm/min	
•	a) RHODUNA [®] Diamond Bright Rhodium Concentrate (2 g Rh/100 ml; containing acid) 100 ml for 1 litre of electrolyte with 2 g/l Rh			This value is given as a rough guide only since the deposition speed de- pends on type and rotation of the barrel as well as shape and number of parts in the barrel.	
	 Storage stability: min. 2 years b) RHODUNA[®] Diamond Bright Additive Solution 100 ml for 1 litre of electrolyte Storage stability: min. 2 years 		Loading per litre:	Max. 1 A/I	

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Calculation of Coating Thickness and Plating Time

Coating weight in mg = surface in cm² x 1.2 x coating thickness in µm

Plating time in minutes = required coating weight in mg deposition rate in mg/Amin x current in amperes

Electrolyte Replenishment

The rhodium content of the electrolyte should be constantly kept at 2 g/l. Replenish at the latest when 20 % of the rhodium content (= 0.4 g/l Rh) have been consumed.

Per 1 g of Rh deposited, add to the electrolyte:

20 ml/l RHODUNA[®] Diamond Bright Replenisher Solution (5 g Rh/100 ml)

At 1 A/dm² (44 % current efficiency), 1 g of rhodium will be deposited after a charge transfer of 106 ampereminutes, at 2 A/dm² after 171 ampere-minutes (values for 40 °C).

Electrolyte Monitoring and Correction

Keep the electrolyte clean. Cover when not in use and remove the platinized titanium anodes from the electrolyte. Store in a closed bottle when not in use for a longer period of time. Filter turbid electrolytes.

Always correct the **rhodium content** with RHODUNA[®] Diamond Bright Replenisher Solution (5 g Rh/100 ml).

An **active carbon treatment**, e.g. for removing organic contaminants, can be carried out without any significant loss of rhodium. Add 2 g of active carbon per litre of electrolyte in a separate tank, stir for 2 hours at operating temperature and then filter.

The important organic components withdrawn from the rhodium electrolyte during this treatment can be easily replenished by adding RHODUNA[®] Diamond Bright Replenisher Solution.

Avoid all **metallic contaminants** (silver and copper in particular) and the drag-in of cyanide!

Special Process Hints

Pre-treatment:Etch, grind, polish etc. the base metal to achieve the desired initial surface condition. Pre-degrease the parts, e.g. in an alkaline cleaning solution or an ultrasonic bath. Rinse, then degrease electrolytically, rinse under running water, and finally with deionized water.Strike nickel plating:RHODUNA® Diamond Bright can be directly deposited on silver, gold, copper and copper alloys, nickel and nickel alloys. When plating tin, lead, zinc, aluminium and iron, interme- diate nickel coatings of some micro- metres thickness are absolutely essential.Acid dip:After strike nickel plating, rinse thoroughly. Each rinsing operation before rhodium plating should con- sist of rinsing under running water followed by rinsing with deionized water.Acid dip:After degreasing or strike nickel plat- ing, dip the workpieces in 5 vol.% sulphuric acid (chemically pure) at room temperature before hanging them into the rhodium electrolyte to ensure that no alkalis are dragged into the rhodium electrolyte.Rhodium plating:After the acid dip, drain the work- pieces quickly, connect to current and hang into the rhodium plating should always be an acid dip treat- ment.Rhodium plating:After the acid dip, drain the work- pieces quickly, connect to current and hang into the rhodium platic should always be an acid dip treat- ment.Post-treatment:Allow the electrolyte fluid to drain off thoroughly. Rinse in deionized water, then in running water and - if possi- ble - also in hot water. Dry immedi- ately. Use the first recovery rinse water for topping up the rhodium electrolyte.	Special Pro	cess Hints
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Equipment

Electrolyte tanks:	Tanks of acid-proof materials, preferably polypropylene.
Accessories:	All plastic parts coming into contact with the electrolyte, e.g. electrolyte tanks, rack insulation, barrels, pumps and hoses, prior to use must be acidified in 5 - 10 % cold sul- phuric acid for approx. 24 hours.
	Very important: Prior to use, filter cartridges must be boiled in 10 % sulphuric acid for approx. 3 hours. Then they are in- serted into the pump and thoroughly rinsed with water. It is essential to change the water several times.
Product agitation:	Optional. Mechanical tapping to dis- lodge adhering hydrogen bubbles is recommended.
Anodes:	Platinized titanium, e. g. PLATINODE [®] coated with 2.5 µm of platinum, or iridium mixed metal oxide MMO, e.g. PLATINODE [®] 177 or 187. We recommend removing the an- odes from the electrolyte during non- plating periods (during the night).
	Ratio of anode area to parts area at least 1 : 1.
Current source:	Infinitely variable, with current display and ampere-hour meter; residual ripple < 5 %.
Exhaust system:	Required for large electrolytes (strongly acidic electrolyte mists entrained by evolution of hydrogen).

Note

Our information relating to the storage stability refers to storage in closed original storage containers under the conditions stated on the label.

Precautionary Measures/Safety Hints

For information on safety, please see the corresponding Material Safety Data Sheets! The valid accident prevention regulations and safety information must be observed. The information and statements contained herein are provided free of charge. They are believed to be accurate at the time of publication, but we make no warranty with respect thereto, including but not limited to any results to be obtained or the infringement of any proprietary rights.

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